



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	V _{(BR)DSS}	R _{DS(on)}	Ι _D T _A = +25°C		
Q1	30V	60mΩ @ V _{GS} = 10V	3.4A		
	500	100mΩ @ V _{GS} = 4.5V			
Q2	-30V	95mΩ @ V _{GS} = -10V	-2.8A		
QZ	-30 V	140mΩ @ V _{GS} = -4.5V	-2.3A		

Description and Applications

This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(on)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Backlighting
- DC-DC Converters
- Power Management Functions

Features and Benefits

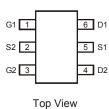
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

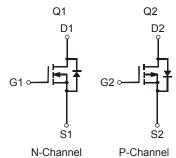
Mechanical Data

- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.013 grams (Approximate)



Top View





Ordering Information (Note 5)

Part Number	Case	Packaging
DMG6602SVTQ-7	TSOT26	3,000 / Tape & Reel
DMG6602SVTQ-13	TSOT26	10,000 / Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

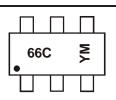
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



66C = Product Type Marking Code YM = Date Code Marking

Y = Year (ex: X = 2010)

M = Month (ex: 9 = September)

Date Code Key

Date Obuc Rey												
Year	2010	2011	2012	2013	201	4 20	015	2016	2017	2018	2019	2020
Code	Х	Y	Z	A	В		С	D	E	F	G	Н
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

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DMG6602SVTQ Document number: DS37643 Rev. 1 - 2



Maximum Ratings – Q1 (@TA = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V _{DSS}	30	V
Gate-Source Voltage	V _{GSS}	±20	V		
Continuous Drain Current (Note 7) V _{GS} = 10V	Steady State	T _A = +25°C T _A = +70°C	ID	3.4 2.7	А
Continuous Drain Current (Note 7) V_{GS} = 4.5V	Steady State	T _A = +25°C T _A = +70°C	Ι _D	2.7 2.2	А
Maximum Continuous Body Diode Forward Current (ls	1.5	A		
Pulsed Drain Current (Note 5)	I _{DM}	25	A		

Maximum Ratings – Q2 (@TA = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V _{DSS}	-30	V
Gate-Source Voltage				±20	V
Continuous Drain Current (Note 7) V_{GS} = -10V	Steady State	T _A = +25°C T _A = +70°C	Ι _D	-2.8 -2.4	A
Continuous Drain Current (Note 7) V_{GS} = -4.5V	Steady State	T _A = +25°C T _A = +70°C	Ι _D	-2.3 -2.1	А
Maximum Continuous Body Diode Forward Current (ls	-1.5	A		
Pulsed Drain Current (Note 7)	I _D	-20	A		

Thermal Characteristics

Characteristic		Symbol	Value	Units	
Tatal Dawar Dissinction (Nata 6)	T _A = +25°C	D	0.84	W	
Total Power Dissipation (Note 6)	T _A = +70°C	PD	0.52		
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	D	155	°C/W	
	t<10s	$R_{ extsf{ heta}JA}$	109		
Total Power Dissipation (Note 7)	T _A = +25°C	P	1.27	W	
	T _A = +70°C	PD	0.8		
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	D	102		
	t<10s	$R_{ extsf{ heta}JA}$	71	°C/W	
Thermal Resistance, Junction to Case (Note 7)		$R_{ ext{ heta}JC}$	34		
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C	

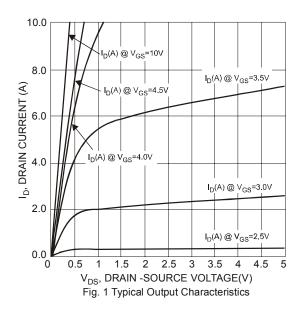
Notes:6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.7. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

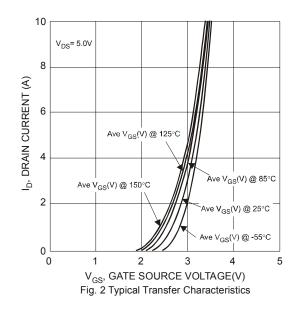


Electrical Characteristics – Q1 N	MMOS (@ T _A = +25	°C unless	otherwis	e stated.)		
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						-
Drain-Source Breakdown Voltage	BV _{DSS}	30	-	-	V	$V_{GS} = 0V, I_{D} = 250 \mu A$
Zero Gate Voltage Drain Current	IDSS	-	-	1.0	μA	$V_{DS} = 24V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	-	-	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(th)}	1.0	-	2.3	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Static Drain-Source On-Resistance	Descent		38	60	mΩ	V _{GS} = 10V, I _D = 3.1A
	R _{DS} (ON)	-	55	100	11152	V _{GS} = 4.5V, I _D = 2A
Forward Transfer Admittance	Y _{fs}	-	4	-	S	V _{DS} = 5V, I _D = 3.1A
Diode Forward Voltage	V _{SD}	-	0.8	1	V	$V_{GS} = 0V, I_{S} = 1A$
DYNAMIC CHARACTERISTICS (Note 9)						-
Input Capacitance	Ciss	-	290	400		
Output Capacitance	Coss	-	40	80	pF	V _{DS} = 15V, V _{GS} = 0V, f = 1.2MHz
Reverse Transfer Capacitance	C _{rss}	-	40	80	1	
Gate Resistance	Rg	-	1.4	-	Ω	V_{DS} = 0V, V_{GS} = 0V, f = 1MHz
Total Gate Charge (V _{GS} = 4.5V)	Qg	-	4	6		V _{DS} = 15V, V _{GS} = 4.5V, I _D = 3.1A
Total Gate Charge (V _{GS} = 10V)	Qg	-	9	13	nC	
Gate-Source Charge	Q _{qs}	-	1.2	-	nc	V _{DS} = 15V, V _{GS} = 10V, I _D = 3A
Gate-Drain Charge	Q _{qd}	-	1.5	-		
Turn-On Delay Time	t _{D(on)}	-	3	-		
Turn-On Rise Time	tr	-	5	-	1	V _{GS} = 10V, V _{DS} = 15V,
Turn-Off Delay Time	t _{D(off)}	-	13	-	ns	$R_G = 3\Omega, R_L = 4.7\Omega$
Turn-Off Fall Time	tf	-	3	-	1	

8. Short duration pulse test used to minimize self-heating effect. Notes:

9. Guaranteed by design. Not subject to product testing.







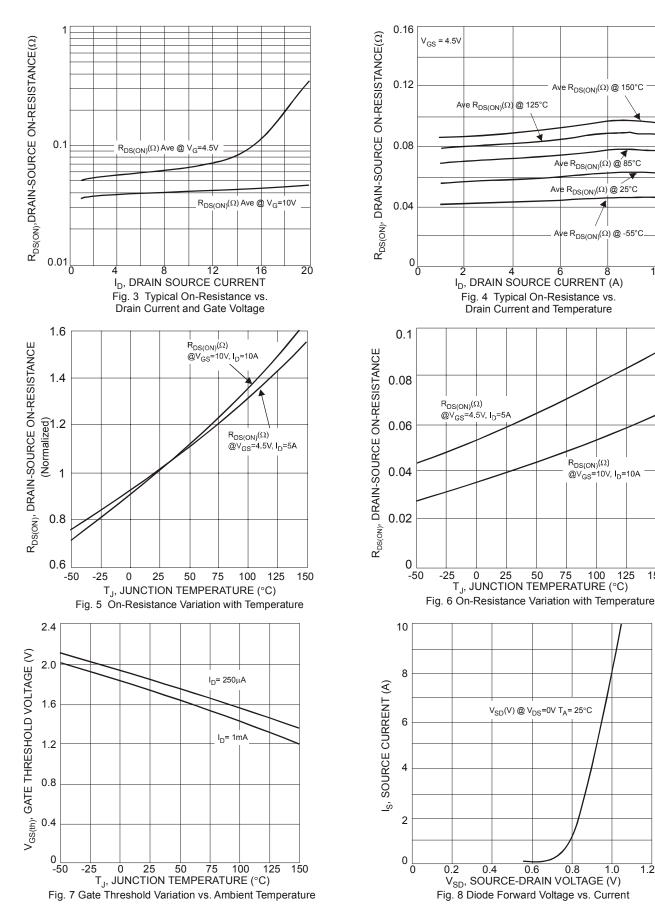
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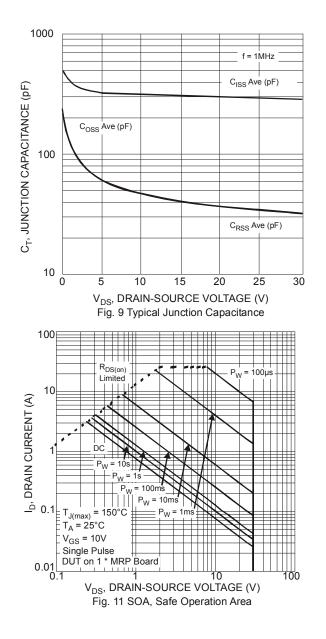
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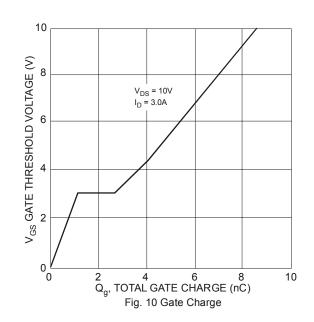


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1.0





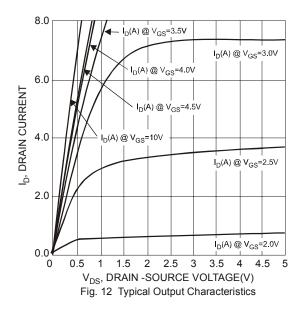


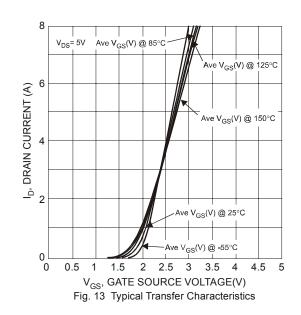


Electrical Characteristics – Q2 PMOS (@ T_A = +25°C unless otherwise stated.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV _{DSS}	-30	-	-	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}	-	-	-1.0	μA	$V_{DS} = -24V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	-	-	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(th)}	-1.0	-	-2.3	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
Static Drain-Source On-Resistance	P		73	95	mΩ	V _{GS} = -10V, I _D = -2.7A
	R _{DS (ON)}	-	99	140	11152	V _{GS} = -4.5V, I _D = -2A
Forward Transfer Admittance	Y _{fs}	-	6	-	S	$V_{DS} = -5V, I_D = -2.7A$
Diode Forward Voltage	V _{SD}	-	-0.8	-1.0	V	$V_{GS} = 0V, I_{S} = -1A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss	-	350	420		V _{DS} = -15V, V _{GS} = 0V, f = 1.2MHz
Output Capacitance	Coss	-	50	100	pF	
Reverse Transfer Capacitance	C _{rss}	-	45	80		1 - 1.210112
Gate Resistance	Rg	-	17.1	-	Ω	V_{DS} = 0V, V_{GS} = 0V, f = 1MHz
Total Gate Charge (V _{GS} = -4.5V)	Qg	-	4	6		V_{DS} = -15V, V_{GS} = -4.5V, I_{D} = -3A
Total Gate Charge (V _{GS} = -10V)	Qq	-	7	9		
Gate-Source Charge	Q _{gs}	-	0.9	-	nC	V _{DS} = -15V, V _{GS} = -10V, I _D = -3A
Gate-Drain Charge	Q _{gd}	-	1.2	-	1	
Turn-On Delay Time	t _{D(on)}	-	4.8	-		
Turn-On Rise Time	tr	-	7.3	-]	V _{GS} = -10V, V _{DS} = -15V,
Turn-Off Delay Time	t _{D(off)}	-	20	-	ns	$R_G = 6\Omega, R_L = 15\Omega$
Turn-Off Fall Time	tf	-	13	-	1	

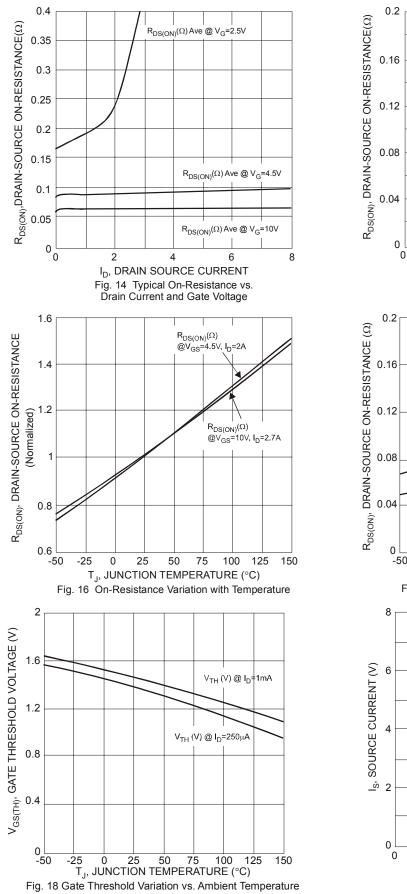
Notes: 8. Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to production testing.







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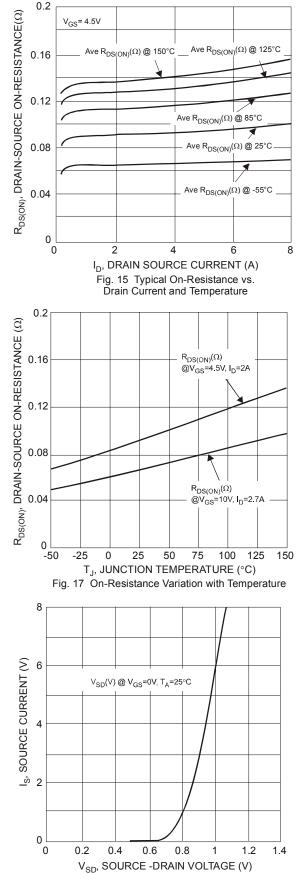
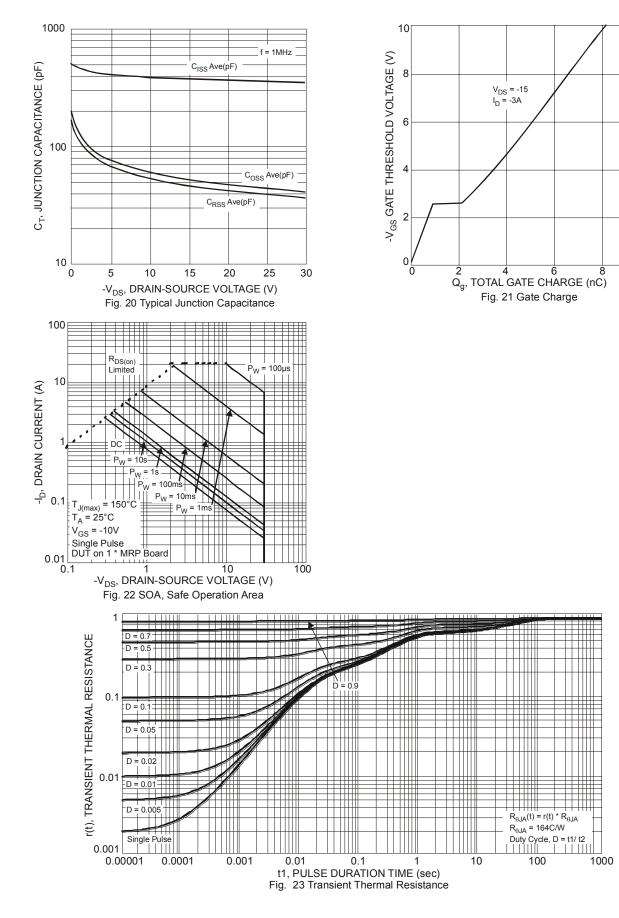


Fig. 19 Diode Forward Voltage vs. Current



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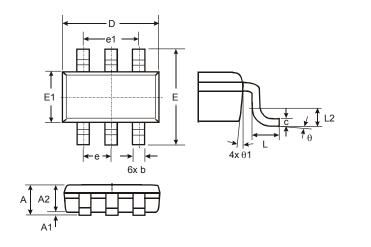
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Package Outline Dimensions

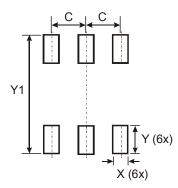
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



TSOT26						
Dim	Min	Max	Тур			
Α	-	- 1.00				
A1	0.01	0.10	-			
A2	0.84	0.90	-			
D	-	-	2.90			
Е	-	-	2.80			
E1	-	-	1.60			
b	0.30	0.45	-			
С	0.12	0.20	-			
е	-	-	0.95			
e1	-	-	1.90			
L	0.30	0.50				
L2	-	-	0.25			
θ	0°	8°	4°			
θ1	4°	12°	-			
All D	imensi	ons in	mm			

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.199



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